

Package outlines

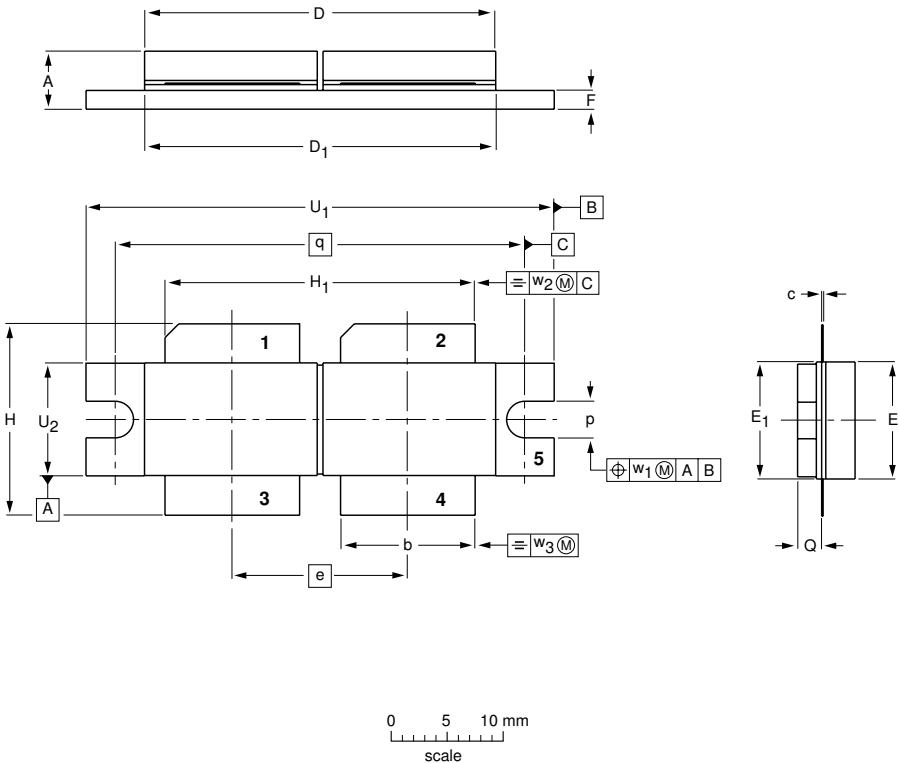
Chapter 2

Flanged double-ended ceramic (AlN) package; 2 mounting holes; 4 leads

SOT494A


Package under development

Philips Semiconductors reserves the right to make changes without notice.



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D <sub>1</sub>	E	E <sub>1</sub>	e	F	H	H <sub>1</sub>	p	Q	q	U <sub>1</sub>	U <sub>2</sub>	w <sub>1</sub>	w <sub>2</sub>	w <sub>3</sub>
mm	5.26 4.60	11.81 11.56	0.15 0.10	33.96 28.02	31.37 30.61	10.26 10.06	10.29 10.03	15.75	1.66 1.60	16.74 16.48	27.81 27.05	3.30 3.05	2.21 2.06	36.07	41.28 41.02	10.29 10.03	0.25	0.51	0.25
inches	0.207 0.181	0.465 0.455	0.006 0.004	1.337 1.103	1.235 1.205	0.404 0.396	0.405 0.395	0.62	0.065 0.063	0.659 0.649	1.095 1.065	0.130 0.120	0.087 0.081	1.42	1.625 1.615	0.405 0.395	0.01	0.02	0.01

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT494A						99-03-30